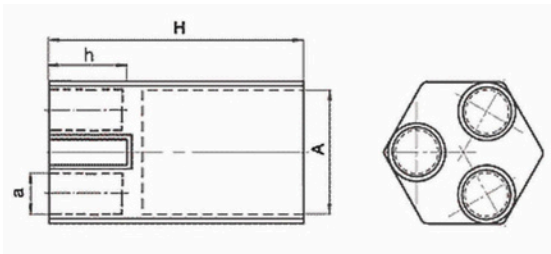


Heat shrink breakout boots with glue

4-core and 5-core



Operating temperature	-30°C up to +135°C	Dielectric Strength	minimum 10kV/mm
Shrink Temperature	> +125°C	Resistance to Heat Shock	no cracks, no flow
Elongation at Rupture	min. 300%	Resistance to UV	UV proof
Tensile Strength	no less than 13 MPa	Color	black



A - inner diameter before shrinking
A1 - inner diameter after shrinking
a - inner diameter of finger
a1 - inner diameter of finger after shrinking
H - length
h - length of finger

Product name	Index	Number of cores	Dimensions [mm]						Wall thickness	Core thickness
			A	A1	a	a1	H	h		
Heat shrink breakout boots 4c 16-50mm ²	TRSY-1/4.0	4	40.0	27.0	12.0	6.0	122.0	44.0	2.0	1.5
Heat shrink breakout boots 4c 50-95mm ²	TRSY-1/4.1	4	53.0	35.0	16.0	8.0	148.0	50.0	2.5	2.0
Heat shrink breakout boots 4c 120-185mm ²	TRSY-1/4.2	4	75.0	50.0	26.0	13.0	170.0	58.0	3.0	2.0
Heat shrink breakout boots 4c 185-400mm ²	TRSY-1/4.3	4	86.0	58.0	34.0	17.0	170.0	52.0	3.0	2.0
Heat shrink breakout boots 5c 16-50mm ²	TRSY-1/5.00	5	40.0	27.0	12.0	6.0	122.0	44.0	2.0	1.5
Heat shrink breakout boots 5c 50-95mm ²	TRSY-1/5.1	5	53.0	35.0	16.0	8.0	148.0	50.0	2.5	2.0

